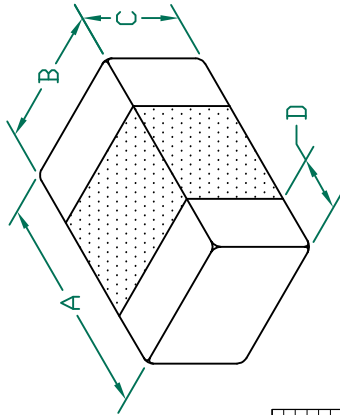


LF0805A252R-10

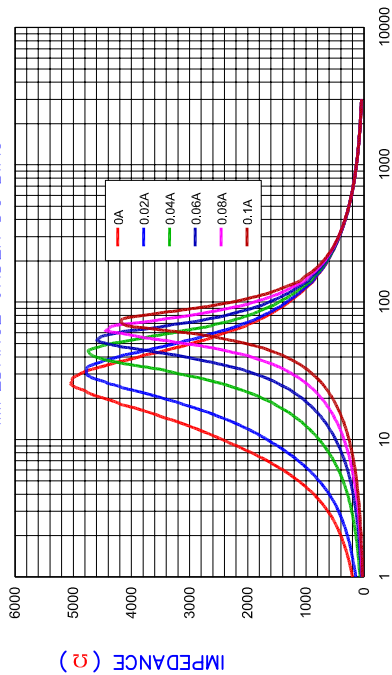
UNCONTROLLED
DOCUMENT

PHYSICAL DIMENSIONS:

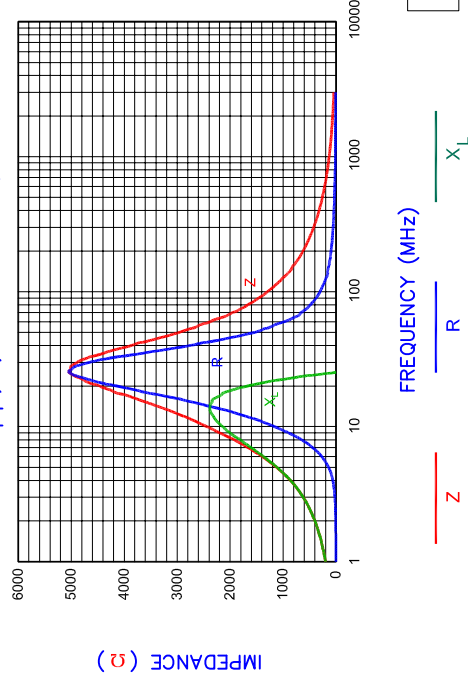
A	2.00	[.079]	± 0.20	[.008]
B	1.25	[.049]	± 0.20	[.008]
C	1.25	[.049]	± 0.20	[.008]
D	0.51	[.020]	± 0.25	[.010]



Z vs FREQUENCY
IMPEDANCE UNDER DC BIAS



|Z|, R, AND X vs. FREQUENCY



AGILENT E4991A RF Impedance/Material Analyzer
HP 16194A Test Fixture. TEST REF. 5806

FREQUENCY (MHz)

$\frac{R}{X_L}$

PROHS
2002/95/EC

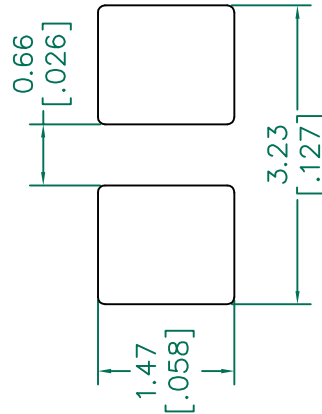
ELECTRICAL CHARACTERISTICS:

Z @ 10MHz (Ω)	DCR (Ω)	Rated Current
Nominal	2500	
Minimum	1875	
Maximum	3125	100 mA

NOTES: UNLESS OTHERWISE SPECIFIED

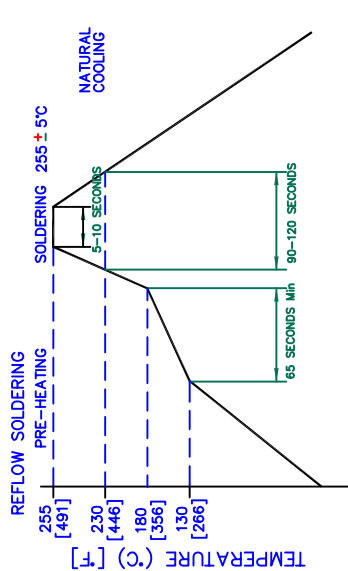
1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, EMBOSSED PLASTIC TAPE 2,000 PCS/REEL.
2. TERMINATION FINISH 100% MATTE TIN.
3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
4. OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.763
[0.030] to this dimension.)

RECOMMENDED SOLDERING CONDITIONS



DIMENSIONS ARE IN mm [INCHES].

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PROJECT/PART NUMBER:		LF0805A252R-10	QU	DATE:	06/15/06	SCALE:	2 of 2
UPDATE COMPANY LOGO		07/03/08	JRK	DATE:	06/15/06	SCALE:	
ORIGINAL DRAFT		09/13/06	JRK	DATE:	06/15/06	SCALE:	
DESCRIPTION		INT	LF0805A252R-10-C	DATE:	06/15/06	SCALE:	

Laird